| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|----------|------|--|----------------------------------|---------------------|---------|------------------|
| Ĺ1 | 4019 | 438/595.ccls. 438/638.ccls. 438/639.ccls. 438/640.ccls. 438/672.ccls. 438/675.ccls. 257/775.ccls. | US-PGPUB; USPAT | OR | OFF | 2005/04/05 09:18 |
| L2 | 120 | (438/595.ccls. 438/638.ccls. 438/639.ccls. 438/640.ccls. 438/672.ccls. 438/675.ccls. 257/775.ccls.) and ((gate wordline bitline ((word bit metal coduct\$6) adj (line trace runner interconnect\$6))) same (hole opening via trench groove window) same (contact plug stud land\$6 pad) same (taper\$6 funnel conical cone (isotropic\$8 with etch\$6))) | US-PGPUB; USPAT | OR | ON | 2005/04/05 10:59 |
| L3 | 91 | (438/595.ccls. 438/638.ccls. 438/639.ccls. 438/640.ccls. 438/672.ccls. 438/675.ccls. 257/775.ccls.) and (((hole opening via trench groove window) with (liner spacer sidewall (side adj wall))) same (contact plug stud land\$6 pad) same (taper\$6 funnel conical cone)) | US-PGPUB; USPAT | OR | ON | 2005/04/05 09:44 |
| L4 | 121 | ((gate wordline bitline ((word bit metal coduct\$6) adj (line trace runner interconnect\$6))) same ((hole opening via trench groove window) with (liner spacer sidewall (side adj wall))) same (contact plug stud land\$6 pad) same (taper\$6 funnel conical cone)) and (semiconductor wafer silicon substrate) | US-PGPUB; USPAT | OR , | ON | 2005/04/05 09:52 |
| L5 | 208 | (gate wordline bitline ((word bit metal coduct\$6) adj (line trace runner interconnect\$6))) and (hole opening via trench groove window) and (contact plug stud land\$6 pad) and (taper\$6 funnel conical cone) and (semiconductor wafer silicon substrate) | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/05 11:06 |
| L6 | 215 | ((hole opening via trench groove window) with (liner spacer sidewall (side adj wall))) and (contact plug stud land\$6 pad) and (taper\$6 funnel conical cone) and (semiconductor wafer silicon substrate) | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/05 10:08 |

| L7 | 348 | ((gate wordline bitline ((word bit metal coduct\$6) adj (line trace runner interconnect\$6))) same ((hole opening via trench groove window) with (taper\$6 funnel conical cone)) same (contact plug stud land\$6 pad)) and (semiconductor wafer silicon substrate) | US-PGPUB; USPAT | OR | ON | 2005/04/05 11:13 |
|-----|------|---|----------------------------------|------|----|------------------|
| L8 | 677 | (438/595.ccls. 438/638.ccls. 438/639.ccls. 438/640.ccls. 438/672.ccls. 438/675.ccls. 257/775.ccls.) and ((gate wordline bitline ((word bit metal coduct\$6) adj (line trace runner interconnect\$6))) same (hole opening via trench groove window) same (contact plug stud land\$6 pad) same (liner spacer sidewall (side adj wall))) | US-PGPUB; USPAT | OR . | ON | 2005/04/05 11:04 |
| L9 | 131 | (438/595.ccls. 438/638.ccls. 438/639.ccls. 438/640.ccls. 438/672.ccls. 438/675.ccls. 257/775.ccls.) and ((gate wordline bitline ((word bit metal coduct\$6) adj (line trace runner interconnect\$6))) same (hole opening via trench groove window) same (contact plug stud land\$6 pad) same (liner barrier adhesion) same (spacer sidewall (side adj wall))) | US-PGPUB; USPAT | OR | ON | 2005/04/05 11:17 |
| L10 | 1156 | (438/595.ccls. 438/638.ccls. 438/639.ccls. 438/640.ccls. 438/672.ccls. 438/675.ccls. 257/775.ccls.) and ((gate wordline bitline ((word bit metal coduct\$6) adj (line trace runner interconnect\$6))) same (hole opening via trench groove window contact plug stud land\$6 pad) same (liner spacer sidewall (side adj wall))) | US-PGPUB; USPAT | OR | ON | 2005/04/05 15:37 |
| L11 | 4547 | (gate wordline bitline ((word bit metal coduct\$6) adj (line trace runner interconnect\$6))) and (hole opening via trench groove window) and (contact plug stud land\$6 pad) and (liner spacer sidewall (side adj wall)) and (semiconductor wafer silicon substrate) | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/05 11:08 |

| L12 | 3340 | (gate wordline bitline ((word bit | EPO; JPO; | OR | ON | 2005/04/05 11:07 |
|------------|------|---|----------------------------------|----|----|------------------|
| L 2 | 3310 | metal coduct\$6) adj (line trace runner interconnect\$6))) same (hole opening via trench groove window) same (contact plug stud land\$6 pad) same (liner spacer sidewall (side adj wall)) | DERWENT; IBM_TDB | | | . , , , |
| L13 | 1666 | (gate wordline bitline ((word bit metal coduct\$6) adj (line trace runner interconnect\$6))) same ((hole opening via trench groove window) with (contact plug stud land\$6 pad) with (liner spacer sidewall (side adj wall))) | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/05 11:08 |
| L14 | 505 | (gate wordline bitline ((word bit metal coduct\$6) adj (line trace runner interconnect\$6))) and (hole opening via trench groove window) and (contact plug stud land\$6 pad) and (liner barrier adhesion) and (spacer sidewall (side adj wall)) and (semiconductor wafer silicon substrate) | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/05 11:09 |
| L15 | 180 | ((gate wordline bitline ((word bit metal coduct\$6) adj (line trace runner interconnect\$6))) with (spacer sidewall (side adj wall))) and ((hole opening via trench groove window) with (liner barrier adhesion)) and (contact plug stud land\$6 pad) | EPO; JPO; DERWENT; IBM_TDB | OR | ON | 2005/04/05 12:22 |
| L16 | 442 | ((gate wordline bitline ((word bit metal coduct\$6) adj (line trace runner interconnect\$6))) with (spacer sidewall (side adj wall))) same ((hole opening via trench groove window) with (liner barrier adhesion)) same (contact plug stud land\$6 pad) | US-PGPUB; USPAT | OR | ON | 2005/04/05 11:15 |
| L17 | 434 | 16 and (semiconductor wafer silicon substrate) | US-PGPUB; USPAT | OR | ON | 2005/04/05 11:14 |
| L18 | 438 | 16 not 7 | US-PGPUB; USPAT | OR | ON | 2005/04/05 11:14 |
| L19 | 355 | ((gate wordline bitline ((word bit metal coduct\$6) adj (line trace runner interconnect\$6))) with (spacer sidewall (side adj wall))) same ((hole opening via trench groove window) with (liner barrier adhesion) with (contact plug stud land\$6 pad)) | US-PGPUB; USPAT | OR | ON | 2005/04/05 14:30 |